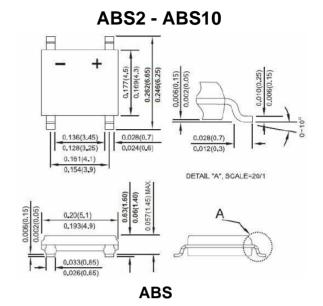


FEATURES

- UL Recognized File # E-326854
- · Ideal for printed circuit board
- Reliable low cost construction utilizing molded plastic technique
- · High surge current capability
- High temperature soldering guaranteed: 260°C/10 seconds /0.375"(9.5mm) lead length at 5 lbs., (2.3kg) tension
- Small size, simple installation
- Green compound with suffix "G" on packing code & prefix "G" on datecode

Mechanical Data

- Terminal: Pure tin plated, lead free, Leads solderable per MIL-STD-202 Method 208
- · Mounting position : as Marking



Maximum Ratings and Electrical Characteristics

Rating at 25 $^{\circ}$ C ambient temperature unless otherwise specified. Single phase, half wave, 60 Hz, resistive or inductive load.

For capacitive load, derate current by 20%

Type Number	Symbol	ABS2	ABS4	ABS6	ABS8	ABS10	Unit
Maximum Repetitive Peak Reverse Voltage	V_{RRM}	200	400	600	800	1000	V
Maximum RMS Voltage	V_{RMS}	140	280	420	560	700	V
Maximum DC Blocking Voltage	V_{DC}	200	400	600	800	1000	V
Maximum Average Forward Rectified Current On glass-epoxy On aluminum substrate	I _{F(AV)}	0.8 1.0					А
Peak Forward Surge Current, 8.3 ms Single Half Sinewave Superimposed on Rated Load (JEDEC method)	I _{FSM}	30					Α
Maximum Instantaneous Forward Voltage (Note 1) @ 0.4A	V _F	0.95					٧
Rating for fusing (t<8.3mS)	I ² T	3.74					A ² sec
$\begin{tabular}{lllllllllllllllllllllllllllllllllll$	1 1_ 1	10 150					uA
Typical Thermal Resistance (Note 2)	R _{θjL} R _{θjA}	25 80					°C/W
Operating Temperature Range	T_J	- 55 to + 150					οС
Storage Temperature Range	T_{STG}	- 55 to + 150					οС

Note 1: Pulse Test with PW=300 usec,1% Duty Cycle

Note 2: Mounted on P.C.B. with 5mm x 5mm Copper Pads





ABS2 - ABS10 Typical Characteristics

